PRODUCT / PROCESS CHANGE NOTIFICATION

| 1. PCN basic data | | |
|--|--|--|
| 1.1 Company STMicroelectronics International N.V | | STMicroelectronics International N.V |
| 1.2 PCN No. | | MDG/24/14312 |
| 1.3 Title of PCN | | ASE Kaohsiung (Taiwan) UQFN5x5 32L & UQFN7x7 48L package copper palladium bonding wire introduction on STM32C0x, STM32G0x, STM32G4x, STM32L4x and STM32L5x listed products |
| 1.4 Product Category | | STM32C0x, STM32G0x, STM32G4x, STM32L4x, STM32L5x. |
| 1.5 Issue date | | 2024-05-03 |

| 2. PCN Team | | |
|---------------------------|----------------------------|--|
| 2.1 Contact supplier | | |
| 2.1.1 Name | PIKE EMMA | |
| 2.1.2 Phone | +44 1628896111 | |
| 2.1.3 Email | emma.pike@st.com | |
| 2.2 Change responsibility | | |
| 2.2.1 Product Manager | Ricardo Antonio DE SA EARP | |
| 2.1.2 Marketing Manager | Veronique BARLATIER | |
| 2.1.3 Quality Manager | Pascal NARCHE | |

| 3. Change | | |
|--------------|---|----------------------------|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location |
| | Direct Material: Bond Wire - Metallurgy (metallic composition/ raw material) | ASE Kaohsiung (Taiwan) |

| 4. Description of change | | |
|---|---|--|
| | Old | New |
| 4.1 Description | Assembly lines / wire bonding: - JSCC (China) / Gold wire - JSCC (China) / Copper Palladium wire - ASE Kaohsiung (Taiwan) / Gold wire | Assembly lines / wire bonding: - JSCC (China) / Gold wire - JSCC (China) / Copper Palladium wire - ASE Kaohsiung (Taiwan) / Gold wire - ASE Kaohsiung (Taiwan) / Copper Palladium wire - Additional Source |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | | |

| 5. Reason / motivation for change | |
|-----------------------------------|---------------------|
| 5.1 Motivation | To improve service |
| 5.2 Customer Benefit | SERVICE IMPROVEMENT |

| 6. Marking of parts / traceability of change | |
|--|---|
| 6.1 Description | traceability ensured by ST Internal tools |

| 7. Timing / schedule | |
|-------------------------------------|--------------|
| 7.1 Date of qualification results | 2024-04-18 |
| 7.2 Intended start of delivery | 2024-06-17 |
| 7.3 Qualification sample available? | Upon Request |

| 8. Qualification / Validation | |
|-------------------------------|---|
| 8.1 Description | 14312 MDRF-GPM-RER2323 V1.0 - PCN14321 - ASE KH (Taiwan) UQFN 5x5 32L 7x7 48L cu wire - Rel Eval Report.pdf |

| | Available (see attachment) | Issue | 2024-05-03 |
|-----------------------|----------------------------|-------|------------|
| qualification results | | Date | |

9. Attachments (additional documentations)

14312 Public product.pdf 14312 MDRF-GPM-RER2323 V1.0 - PCN14321 - ASE KH (Taiwan) UQFN 5x5 32L 7x7 48L cu wire - Rel Eval Report.pdf 14312 PCN14312_Additional information.pdf

| 10. Affected parts | | |
|-------------------------|-------------------------|--------------------------|
| 10. 1 Current | | 10.2 New (if applicable) |
| 10.1.1 Customer Part No | 10.1.2 Supplier Part No | 10.1.2 Supplier Part No |
| | STM32G0B1CBU6 | |
| | STM32G431C8U6 | |
| | STM32G431CBU6 | |
| | STM32L412KBU6 | |
| | STM32L412KBU6TR | |

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